

ABSTRACT

METHOD AND APPARATUS FOR PROCESSING
AN ARRAY OF COMPONENTS

5

10 The invention provides a method and apparatus for processing an array of
electronic components. It involves providing mounting means to mount
unsingulated components onto the mounting means, singulating the components
to physically separate them, ^{electrically} and testing the singulated electronic components for
defects whilst they are mounted on the mounting means, and without removal
therefrom.

(Figure 4)

15